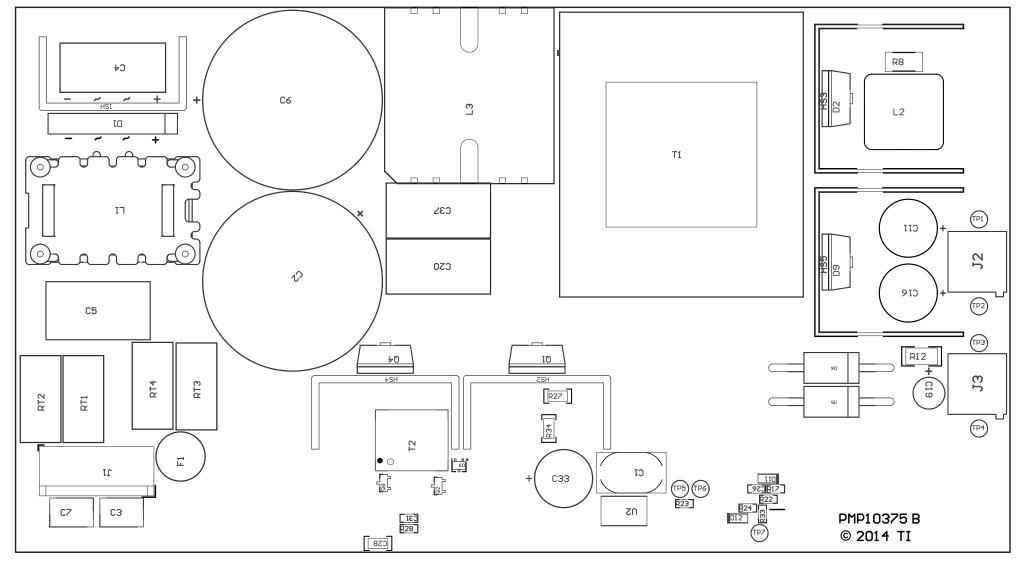
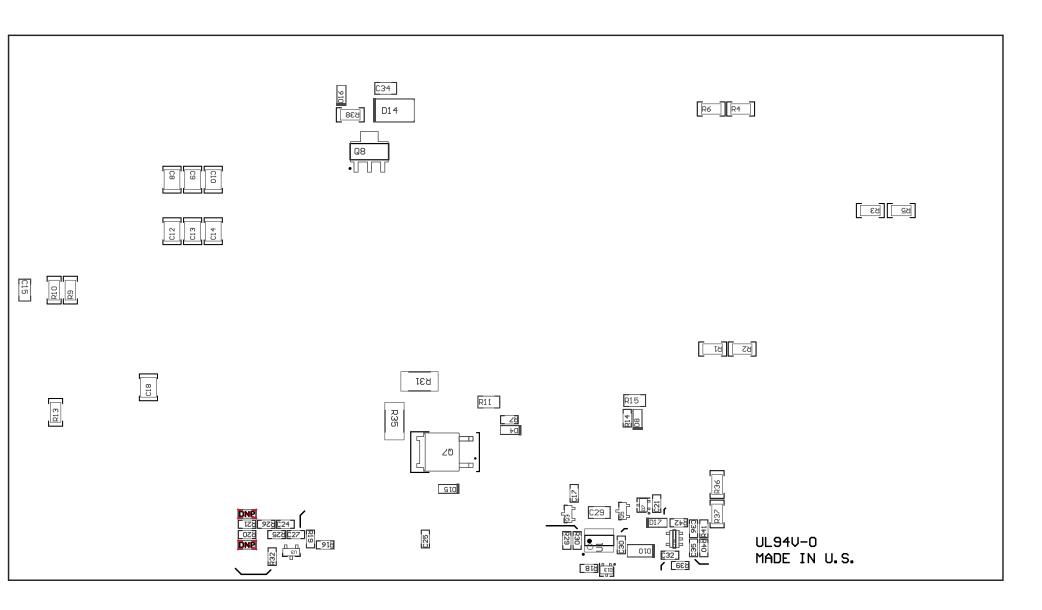
TABLE 1				
Variant	Label text			
001	ChangeMe!			
002	ChangeMe!			



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10375	REV: B	SVN REV:	Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 5/28/2	2015 11:15:31	AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10375 REV: B SVN REV: Not In VersionCor		Not In VersionControl	
	Bottom Overlay <- 390001			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 5/28/2	2015 11:15:32	AM	TEXAS INSTRUMENTS

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